TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (L^2-π-MOSⅤ)

2SK2312

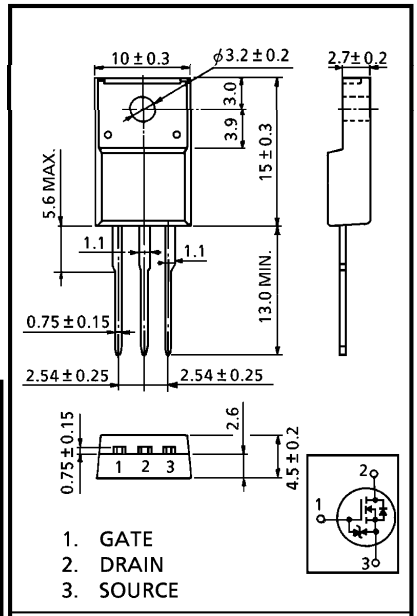
HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

INDUSTRIAL APPLICATIONS

- 4V Gate Drive
- Low Drain-Source ON Resistance : $R_{DS\ (ON)}$ = 13mΩ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}|$ = 40S (Typ.)
- Low Leakage Current : I_{DSS} = 100μA (Max.) (V_{DS} = 60V)
- Enhancement-Mode : V_{th} = 0.8~2.0V (V_{DS} = 10V, I_D = 1mA)

Unit in mm



JEDEC	—
EIAJ	SC-67
TOSHIBA	2-10R1B

Weight : 1.9g

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Drain-Gate Voltage (R_{GS} = 20kΩ)		V_{DGR}	60	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current	DC	I_D	45	A
	Pulse	I_{DP}	180	A
Drain Power Dissipation (Tc = 25°C)		P_D	45	W
Single Pulse Avalanche Energy**		E_{AS}	701	mJ
Avalanche Current		I_{AR}	45	A
Repetitive Avalanche Energy*		E_{AR}	4.5	mJ
Channel Temperature		T_{ch}	150	°C
Storage Temperature Range		T_{stg}	−55~150	°C

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th\ (ch-c)}$	2.78	°C / W
Thermal Resistance, Channel to Ambient	$R_{th\ (ch-a)}$	62.5	°C / W

Note ;

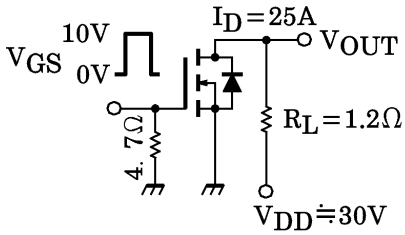
* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

** V_{DD} = 25V, Starting T_{ch} = 25°C, L = 471μH, R_G = 25Ω, I_{AR} = 45A

This transistor is an electrostatic sensitive device.
Please handle with caution.

961001EAA2

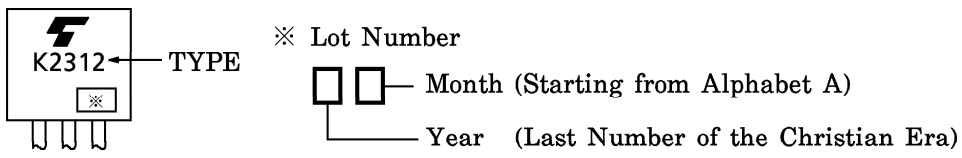
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS}=\pm16V$, $V_{DS}=0V$	—	—	±10	μA
Drain Cut-off Current		I_{DSS}	$V_{DS}=60V$, $V_{GS}=0V$	—	—	100	μA
Drain-Source Breakdown Voltage		$V_{(BR)\,DSS}$	$I_D=10mA$, $V_{GS}=0V$	60	—	—	V
Gate Threshold Voltage		V_{th}	$V_{DS}=10V$, $I_D=1mA$	0.8	—	2.0	V
Drain-Source ON Resistance		$R_{DS\,(ON)}$	$V_{GS}=4V$, $I_D=25A$	—	19	25	mΩ
			$V_{GS}=10V$, $I_D=25A$	—	13	17	
Forward Transfer Admittance		$\|Y_{fs}\|$	$V_{DS}=10V$, $I_D=25A$	28	40	—	S
Input Capacitance		C_{iss}	$V_{DS}=10V$, $V_{GS}=0V$ f=1MHz	—	3350	—	pF
Reverse Transfer Capacitance		C_{rss}		—	550	—	
Output Capacitance		C_{oss}		—	1600	—	
Switching Time	Rise Time	t_r		—	25	—	ns
	Turn-on Time	t_{on}		—	55	—	
	Fall Time	t_f		—	60	—	
	Turn-off Time	t_{off}	V_{IN} : t_r, $t_f<5ns$ Duty ≦ 1%, $t_w=10\mu s$	—	180	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	$V_{DD}\fallingdotseq48V$, $V_{GS}=10V$ $I_D=45A$	—	110	—	nC
Gate-Source Charge		Q_{gs}		—	70	—	
Gate-Drain ("Miller") Charge		Q_{gd}		—	40	—	

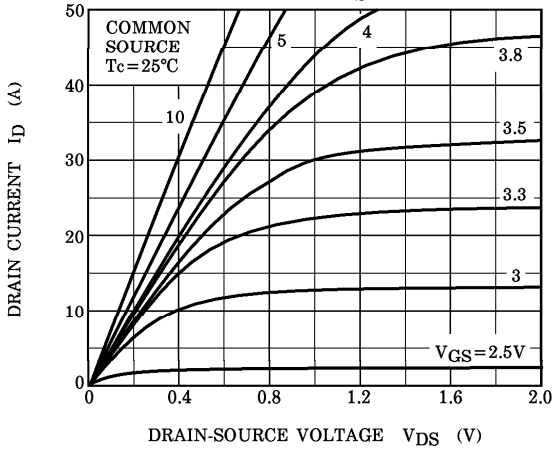
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	45	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	180	A
Diode Forward Voltage	V_{DSF}	$I_{DR}=45A$, $V_{GS}=0V$	—	—	−1.7	V
Reverse Recovery Time	t_{rr}	$I_{DR}=45A$, $V_{GS}=0V$ $dI_{DR}/dt=50A/\mu s$	—	120	—	ns
Reverse Recovery Charge	Q_{rr}		—	0.2	—	μC

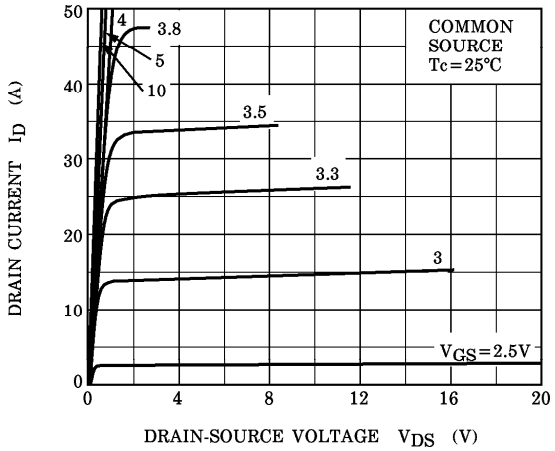
MARKING



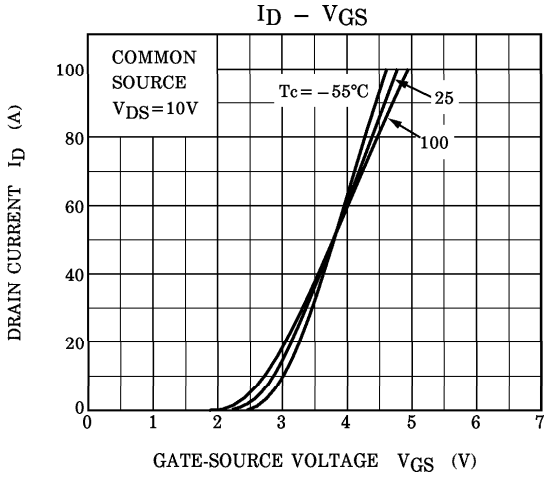
$I_D - V_{DS}$



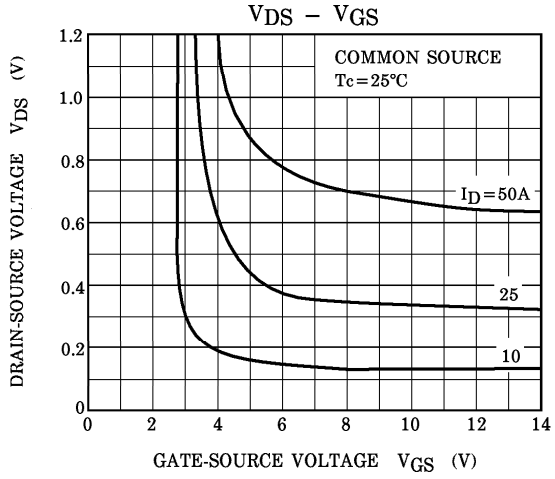
$I_D - V_{DS}$



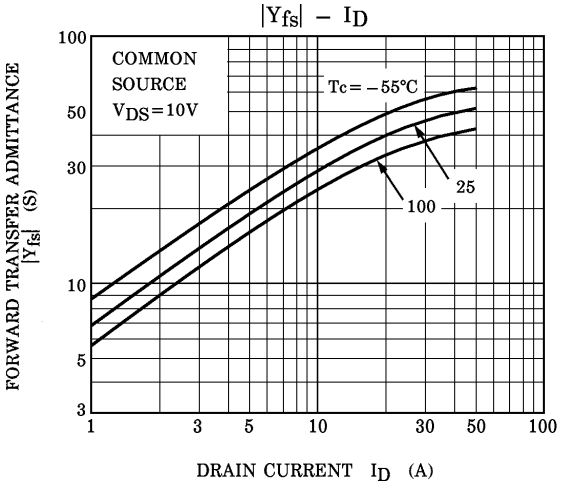
$I_D - V_{GS}$



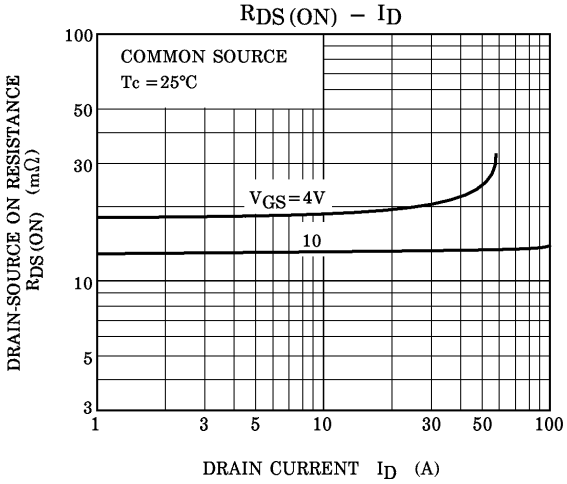
$V_{DS} - V_{GS}$



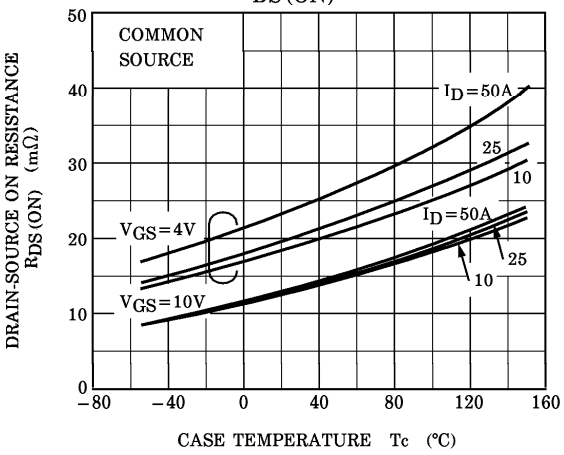
$|Y_{fs}| - I_D$



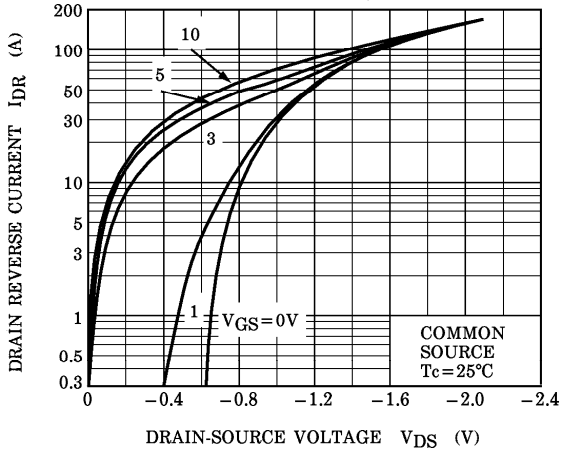
$R_{DS\,(ON)} - I_D$



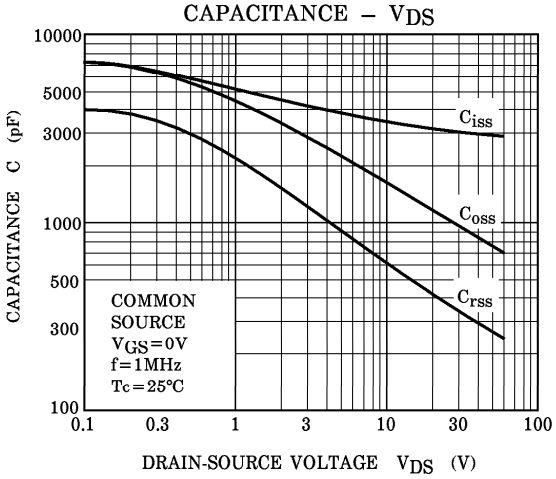
$R_{DS\,(ON)}$ – Tc



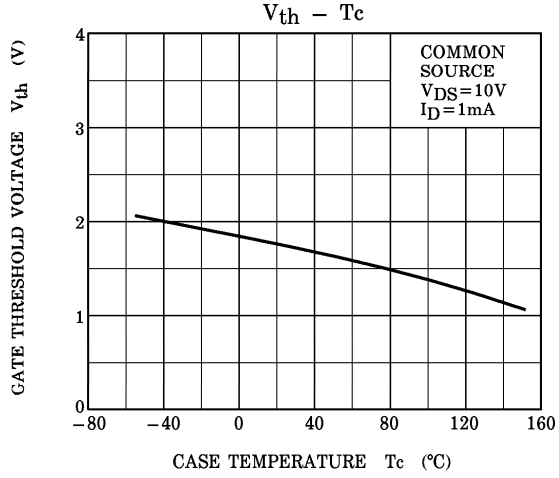
I_{DR} – V_{DS}



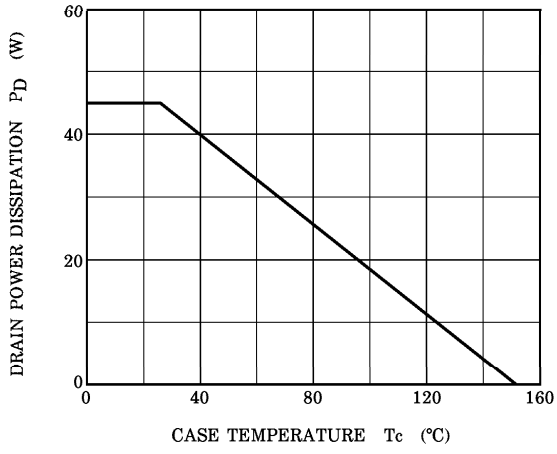
CAPACITANCE – V_{DS}



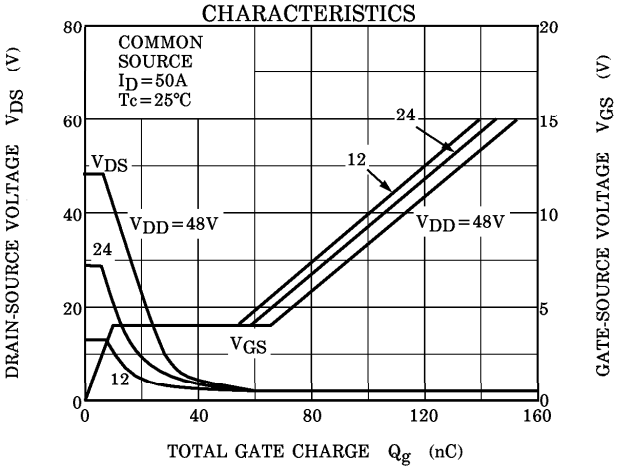
V_{th} – Tc



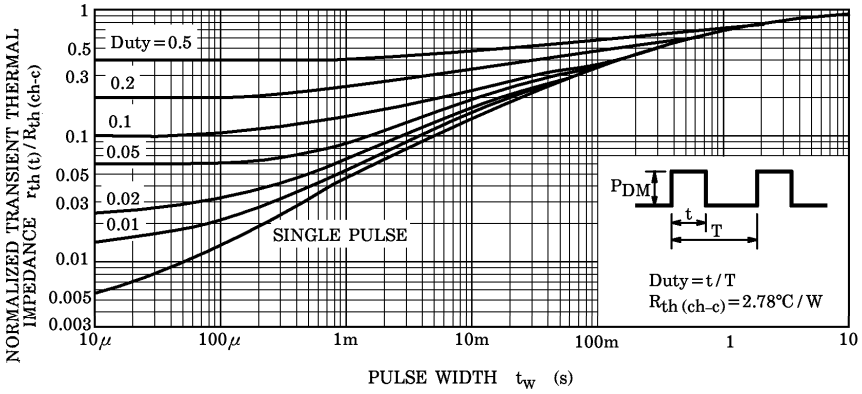
P_D – Tc



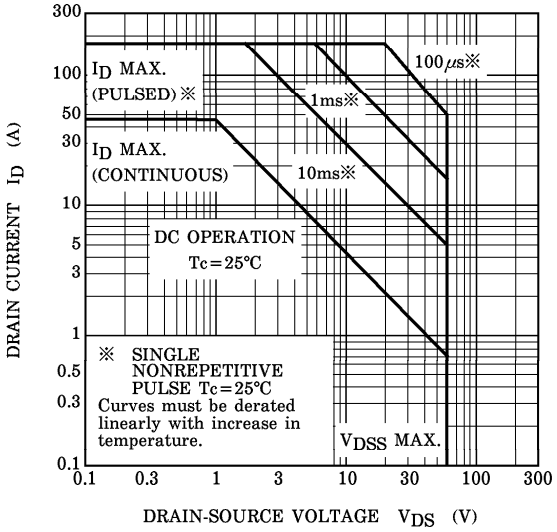
DYNAMIC INPUT / OUTPUT CHARACTERISTICS



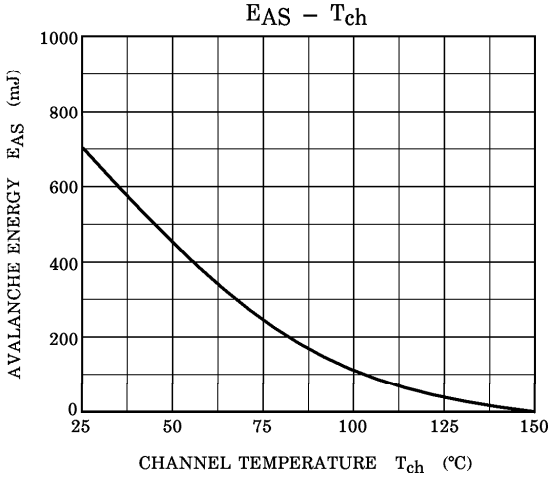
r_{th} – t_w

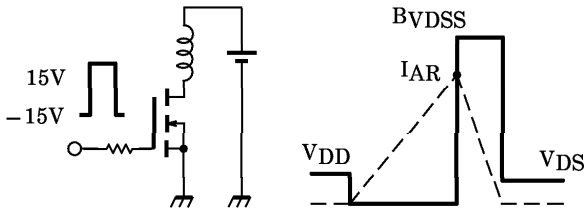


SAFE OPERATING AREA



E_{AS} – T_{ch}





TEST CIRCUIT WAVE FORM

Peak I_{AR}=45A, R_G=25Ω
V_{DD}=25V, L=471μH

$$E_{AS}=\frac{1}{2}\cdot L\cdot I^2\cdot\left(\frac{B_{VDSS}}{B_{VDSS}-V_{DD}}\right)$$